



General Information	
Series	B45196P
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, Molded, High Temperature
Features	High Temperature, Automotive
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200
AEC-Q200	Yes
Notes	Obsolete.

Dimensions	
Footprint	3528
L	3.5mm +/-0.2mm
W	2.8mm +/-0.2mm
H	1.9mm +/-0.2mm
S	0.7mm +/-0.3mm
F	2.2mm +/-0.1mm
K	1.4mm TYP

Packaging Specifications	
Packaging	T&R, 330mm
Packaging Quantity	8000

Specifications	
Capacitance	2.2 uF
Capacitance Tolerance	10%
Voltage DC	25 VDC (85C), 19.92 VDC (125C), 16.75 VDC (150C)
Temperature Range	-55/+150°C
Rated Temperature	85°C
Dissipation Factor	4.5%
Failure Rate	N/A
Resistance	3 Ohms (100kHz)
Ripple Current	168.3 mAmps (25C), 151.5 mAmps (85C), 67.3 mAmps (125C)
Leakage Current	0.6 uA

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